

# AUDREY CHENG

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## EDUCATION

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### Harvard University | Expected 12/2026

Cambridge, MA

B.S. in Mechanical Engineering with a citation in Mandarin Chinese, GPA 3.88

Relevant Coursework: Product Design Process (cross-registered at MIT), Engineering Problem Solving and Design Project, Thermodynamics, Computational Structural and Solid Mechanics, Mechanics of Solids, Computer-Aided Machine Design, Mechanical Systems, Intro to Electrical Engineering, Mechanics and Relativity

## RELEVANT EXPERIENCE

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### Materials Discovery and Applications Group

Boston, MA

*Researcher and Program for Research in Science and Engineering (PRISE) Fellow*

June 2024 – Present

- Designed and optimized a one-way valve using a sequence of multilayer dielectric elastomer actuators.
- Developed 15+ iterative prototypes for a soft pump using SolidWorks, 3D printing, and laser cutting.
- Conducted experimental testing and validation using LabVIEW, HV power supply, and a custom switch box.
- Presented research findings through a technical abstract and oral presentations.

### Radcliffe Institute for Advanced Study

Cambridge, MA

*Radcliffe Research Partner*

September 2024 – January 2025

- Researched HVAC system efficiency and designed ductwork in SolidWorks based on typical gallery airflow for museum installations and ASHRAE standards.
- Applied engineering design and thermodynamics principles to collaborate on an interdisciplinary project bridging technology and artistic design.

### Miller Electric Company

Jacksonville, FL

*Engineering, Prefabrication, and BIM Intern*

March 2025 – August 2025

- Modeled electrical conduit in Revit for large-scale projects, including hospitals and airplane hangars.
- Contributed to the design of Miller Electric Company's new prefabrication shop and offices by preparing permit drawings, luminaire schedules, and load calculations.
- Developed 3D models of prefabrication equipment in Revit and AutoCAD to support internal layout planning and efficiency.

### Harvard University Department of Physics

Cambridge, MA

*Course Assistant for Mechanics and Statistical Physics*

January – May 2024

- Led weekly office hours for 50+ students, clarifying mechanics and statistical physics concepts.
- Evaluated problem sets and guided students through complex problem-solving strategies.

## PROJECTS

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### Wireless Pacman Robotics Project

Built circuits for Bluetooth-controlled robots and developed a light-sensing tag mechanism using Arduino. Designed 3D printed casing components in SolidWorks and troubleshoot hardware/software to optimize performance.

### Robot Competition

Designed and fabricated a robot using SolidWorks and machine tools including 3D printers, CNC mill, lathe, laser cutter, and silicone molding. Conducted tolerance analysis for part fit and created engineering drawings. Placed 4th.

### KoboClicker

Co-led mechanical design of a handheld data-collection device for humanitarian crisis response, developed CAD in Onshape and rapidly prototyped using 3D printing, wrote technical specifications, and conducted device testing.

## SKILLS AND INTERESTS

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**Design & Analysis:** SolidWorks, Fusion, Onshape, AutoCAD, Revit, ABAQUS, COMSOL.

**Software:** MATLAB, Python, LabVIEW, Arduino, HTML & CSS.

**Prototyping & Fabrication:** 3D printing, laser cutting, CNC and manual milling, lathe machining, silicone casting.

**Languages:** English (native), Mandarin Chinese (intermediate-advanced).

**Other Interests:** studio art (sculpture, ceramics), sewing, upcycling, costume design.